

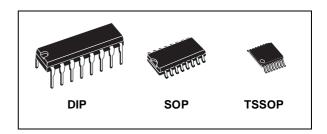
BCD TO 7 SEGMENT LATCH/DECODER/LCD DRIVER

- HIGH SPEED:
 - t_{PD} = 14ns (TYP.) at V_{CC} = 6V
- LOW POWER DISSIPATION: $I_{CC} = 4\mu A(MAX.)$ at $T_A=25$ °C
- HIGH NOISE IMMUNITY: V_{NIH} = V_{NIL} = 28 % V_{CC} (MIN.)
- SYMMETRICAL OUTPUT IMPEDANCE: |I_{OH}| = I_{OL} = 4mA (MIN)
- BALANCED PROPAGATION DELAYS: t_{PLH} ≅ t_{PHL}
- WIDE OPERATING VOLTAGE RANGE: V_{CC} (OPR) = 2V to 6V
- PIN AND FUNCTION COMPATIBLE WITH 74 SERIES 4543



The M74HC4543 is an high speed CMOS BCD-TO-7 SEGMENT DECODER WITH LCD DRIVER fabricated with silicon gate C²MOS technology.

This device consists of BCD-TO-7 segment decoder with a BCD input latch and a 7-segment driver for a liquid crystal display (LCD). When any illegal BCD input signal is applied or input BI is held high, the display is blanked. When driving

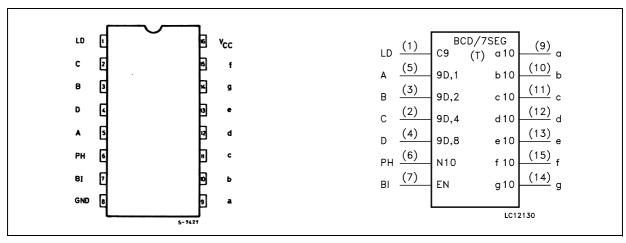


ORDER CODES

PACKAGE	TUBE	T&R			
DIP	M74HC4543B1R				
SOP	M74HC4543M1R	M74HC4543RM13TR			
TSSOP		M74HC4543TTR			

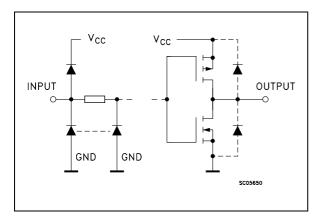
LCDs, a common square wave signal should be applied not only to the PH input of this device but also to the electrically common backplane of the display. For other types of readouts, such as light-emitting diode (LED), some additional drivers, such as a transistor array is required. All inputs are equipped with protection circuits against static discharge and transient excess voltage.

PIN CONNECTION AND IEC LOGIC SYMBOLS



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INPUT AND OUTPUT EQUIVALENT CIRCUIT



PIN DESCRIPTION

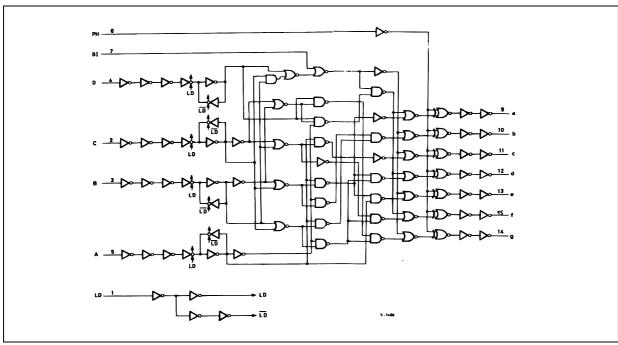
PIN No	SYMBOL	NAME AND FUNCTION
1	LD	Latch Disable Input (Active HIGH)
5, 3, 2, 4	A to D	Address (Data) Inputs
6	PH	Phase Input (Active HIGH)
7	ВІ	Blanking Input (Active HIGH)
9, 10, 11, 12, 13, 15, 14	a to g	Segment Outputs
8	GND	Ground (0V)
16	V _{CC}	Positive Supply Voltage

TRUTH TABLE

			INPUT				OUTPUT							DISPLAY MODE
LD	ВІ	PH	D	С	В	Α	а	b	С	d	е	f	g	DISPLAT MODE
Х	Н	L	Χ	Χ	Χ	Χ	L	L	L	L	L	L	L	BLANK
Н	L	L	L	L	L	L	Н	Н	Н	Н	Н	Н	L	0
Н	L	L	L	L	L	Н	L	Н	Н	L	L	L	L	1
Н	L	L	L	L	Н	L	Н	Н	L	Н	Н	L	Н	2
Н	L	L	L	L	Н	Н	Н	Н	Н	Н	L	L	Н	3
Н	L	L	L	Н	L	L	L	Н	Н	L	L	Н	Н	4
Н	L	L	L	Н	L	Н	Н	L	Н	Н	L	Н	Н	5
Н	L	L	L	Н	Н	L	Н	L	Н	Н	Н	Н	Н	6
Н	L	L	L	Н	Н	Н	Н	Н	Н	L	L	L	L	7
Н	L	L	Н	L	L	L	Н	Н	Н	Н	Н	Н	Н	8
Н	L	L	Н	L	L	Н	Н	Н	Н	Н	L	Н	Н	9
Н	L	L	Н	L	Н	Χ	L	L	L	L	L	L	L	BLANK
Н	L	L	Н	Н	Χ	Χ	L	L	L	L	L	L	L	BLANK
L	L	L	Х	Х	Χ	Х	#####					#####		
1	1	Н		,	<u> </u>		IN	INVERSE OF ABOVE OUTPUT LEVEL					DISPLAY AS ABOVE	

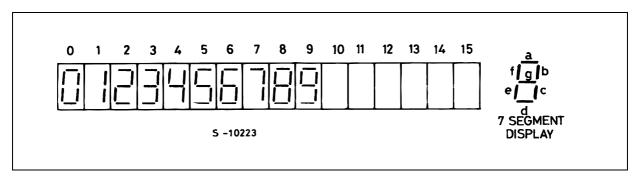
X : Don't Care
↑ : Same as above combinations
: Depends upon the BCD code previously applied when LD ='H'

LOGIC DIAGRAM



This logic diagram has not be used to estimate propagation delays

DISPLAY MODE



ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V _{CC}	Supply Voltage	-0.5 to +7	V
V _I	DC Input Voltage	-0.5 to V _{CC} + 0.5	V
Vo	DC Output Voltage	-0.5 to V _{CC} + 0.5	V
I _{IK}	DC Input Diode Current	± 20	mA
I _{OK}	DC Output Diode Current	± 20	mA
Io	DC Output Current	± 25	mA
I _{CC} or I _{GND}	DC V _{CC} or Ground Current	± 50	mA
P_{D}	Power Dissipation	500(*)	mW
T _{stg}	Storage Temperature	-65 to +150	°C
T_L	Lead Temperature (10 sec)	300	°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied (*) 500mW at 65 °C; derate to 300mW by 10mW/°C from 65°C to 85°C

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RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter		Value	Unit
V _{CC}	Supply Voltage		2 to 6	V
V _I	Input Voltage	0 to V _{CC}	V	
Vo	Output Voltage	0 to V _{CC}	V	
T _{op}	Operating Temperature		-55 to 125	°C
	Input Rise and Fall Time	V _{CC} = 2.0V	0 to 1000	ns
t_r, t_f		V _{CC} = 4.5V	0 to 500	ns
		$V_{CC} = 6.0V$	0 to 400	ns

DC SPECIFICATIONS

		7	est Condition				Value				
Symbol	Parameter	V _{CC}		Т	A = 25°	C	-40 to	85°C	-55 to 125°C		Unit
		(V)		Min.	Тур.	Max.	Min.	Max.	Min.	Max.	
V _{IH}	High Level Input	2.0		1.5			1.5		1.5		
	Voltage	4.5		3.15			3.15		3.15		V
		6.0		4.2			4.2		4.2		
V_{IL}	Low Level Input	2.0				0.5		0.5		0.5	
	Voltage	4.5				1.35		1.35		1.35	V
		6.0				1.8		1.8		1.8	
V _{OH}	High Level Output	2.0	I _O =-20 μA	1.9	2.0		1.9		1.9		
	Voltage	4.5	I _O =-20 μA	4.4	4.5		4.4		4.4		
		6.0	I _O =-20 μA	5.9	6.0		5.9		5.9		V
		4.5	I _O =-4.0 mA	4.18	4.31		4.13		4.10		
		6.0	I _O =-5.2 mA	5.68	5.8		5.63		5.60		
V_{OL}	Low Level Output	2.0	I _O =20 μA		0.0	0.1		0.1		0.1	
	Voltage	4.5	I _O =20 μA		0.0	0.1		0.1		0.1	
		6.0	I _O =20 μA		0.0	0.1		0.1		0.1	V
		4.5	I _O =4.0 mA		0.17	0.26		0.37		0.40	
		6.0	I _O =5.2 mA		0.18	0.26		0.37		0.40	
I _I	Input Leakage Current	6.0	$V_I = V_{CC}$ or GND			± 0.1		± 1		± 1	μΑ
I _{CC}	Quiescent Supply Current	6.0	$V_I = V_{CC}$ or GND			4		40		80	μА

AC ELECTRICAL CHARACTERISTICS ($C_L = 50 \text{ pF}$, Input $t_r = t_f = 6 \text{ns}$)

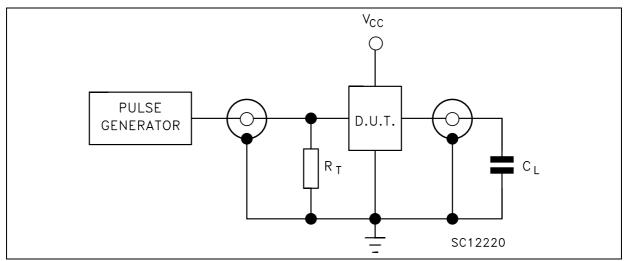
		T	est Condition				Value				
Symbol	Parameter	v _{cc}		Т	A = 25°	С	-40 to	85°C	-55 to 125°C		Unit
		(V)		Min.	Тур.	Max.	Min.	Max.	Min.	Max.	
t _{TLH} t _{THL}	Output Transition	2.0			30	75		95		110	
	Time	4.5			8	15		19		22	ns
		6.0			7	13		16		19	
t _{PLH} t _{PHL}	Propagation Delay Time (BCD - OUT)	2.0			160	300		375		450	
		4.5			40	60		75		90 r	ns
		6.0			30	51		64		76	
t _{PLH} t _{PHL}	Propagation Delay	2.0			80	175		220		265	
	Time (BI - OUT)	4.5			23	35		44		53	ns
		6.0			17	30		37		45	
t _{PLH} t _{PHL}	Propagation Delay	pagation Delay 2.0 4.5		58	130		165		195	ns	
	Time (PH - OUT)			17	26		33		39		
		6.0			14	22		28		33	
t _{PLH} t _{PHL}	Propagation Delay	2.0			130	265		335		400	
	Time (LD - OUT)	4.5			35	53		66		80	ns
		6.0			16	45		56		68	
t _{W(H)}	Minimum Pulse	2.0			30	75		95		110	
()	Width (LD)	4.5			8	15		29		22	ns
		6.0			7	13		26		19	
t _s	Minimum Set Up	2.0			15	75		95		110	
-	Time	4.5			4	15		19		22	ns
	6.0			3	13		16		19		
t _h	Minimum Hold Time	2.0				0		0		0	
		4.5				0		0		0	ns
		6.0				0		0		0	

CAPACITIVE CHARACTERISTICS

		Test Condition		Value							
Symbol	mbol Parameter		V _{CC}		T _A = 25°C			-40 to 85°C		-55 to 125°C	
		(V)	Min.	Тур.	Max.	Min.	Max.	Min.	Max.		
C _{IN}	Input Capacitance	5.0			5	10		10		10	pF
C _{PD}	Power Dissipation Capacitance (note 1)	5.0			115						pF

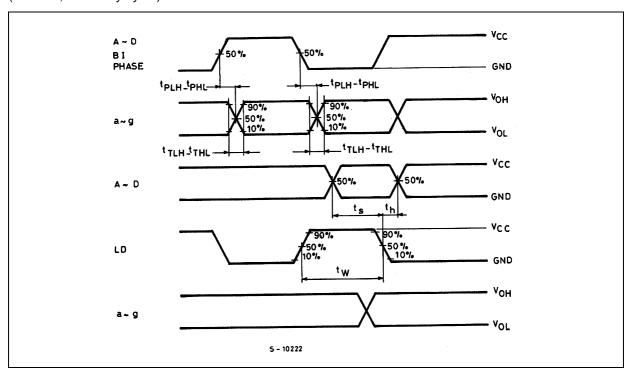
¹⁾ C_{PD} is defined as the value of the IC's internal equivalent capacitance which is calculated from the operating current consumption without load. (Refer to Test Circuit). Average operating current can be obtained by the following equation. $I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{IN} + I_{CC}/2$ (per FLIP/FLOP)

TEST CIRCUIT



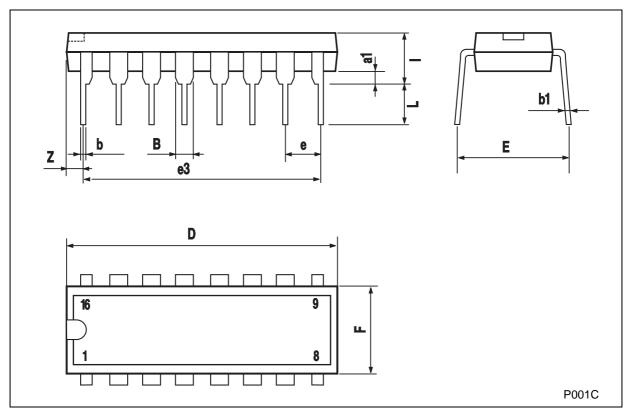
 C_L = 50pF or equivalent (includes jig and probe capacitance) R_T = Z_{OUT} of pulse generator (typically 50 Ω)

WAVEFORM: PROPAGATION DELAY, SETUP AND HOLD TIMES, MINIMUM PULSE WIDTH (LD) (f=1MHz; 50% duty cycle)



Plastic DIP-16 (0.25) MECHANICAL DATA

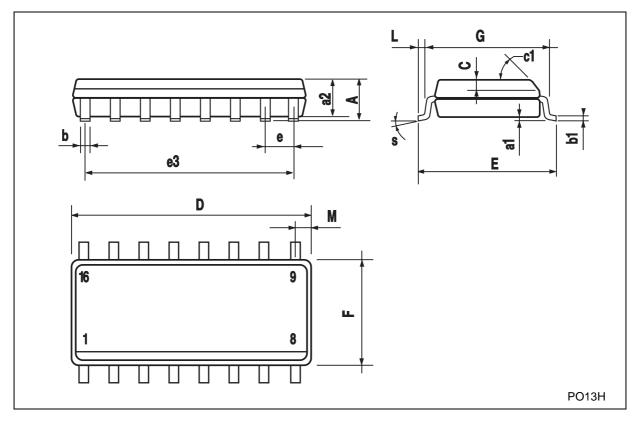
DIM		mm.		inch					
DIM.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.			
a1	0.51			0.020					
В	0.77		1.65	0.030		0.065			
b		0.5			0.020				
b1		0.25			0.010				
D			20			0.787			
E		8.5			0.335				
е		2.54			0.100				
e3		17.78			0.700				
F			7.1			0.280			
I			5.1			0.201			
L		3.3			0.130				
Z			1.27			0.050			





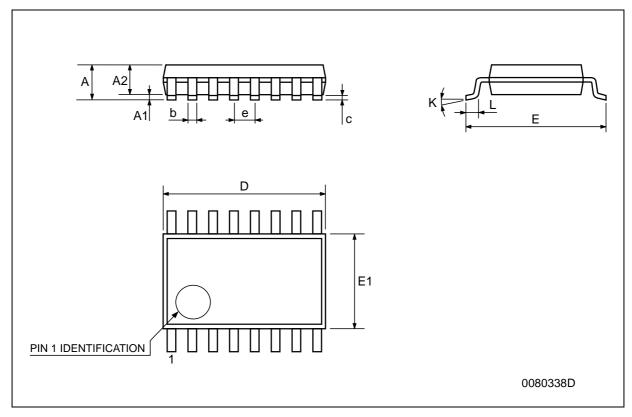
SO-16 MECHANICAL DATA

DIM		mm.			inch	
DIM.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
Α			1.75			0.068
a1	0.1		0.2	0.003		0.007
a2			1.65			0.064
b	0.35		0.46	0.013		0.018
b1	0.19		0.25	0.007		0.010
С		0.5			0.019	
c1			45°	(typ.)	•	•
D	9.8		10	0.385		0.393
E	5.8		6.2	0.228		0.244
е		1.27			0.050	
e3		8.89			0.350	
F	3.8		4.0	0.149		0.157
G	4.6		5.3	0.181		0.208
L	0.5		1.27	0.019		0.050
М			0.62			0.024
S			8° (max.)	!	



TSSOP16 MECHANICAL DATA

DIM		mm.		inch				
DIM.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.		
А			1.2			0.047		
A1	0.05		0.15	0.002	0.004	0.006		
A2	0.8	1	1.05	0.031	0.039	0.041		
b	0.19		0.30	0.007		0.012		
С	0.09		0.20	0.004		0.0089		
D	4.9	5	5.1	0.193	0.197	0.201		
E	6.2	6.4	6.6	0.244	0.252	0.260		
E1	4.3	4.4	4.48	0.169	0.173	0.176		
е		0.65 BSC			0.0256 BSC			
К	0°		8°	0°		8°		
L	0.45	0.60	0.75	0.018	0.024	0.030		



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